Docket No.	
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COMBINED DECLARATION/POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

:

My residen	re nost o	ffice address and	citizenship are as stated belo	w nevt to m	V name
Wiy resident	ce, post o	ince address and	citizensinp are as stated belo	w next to m	y manne.
original, first and jo claimed and for wh	int inventi ich a pate	or (if plural nan	le inventor (if only one name in the sulfines are listed below) of the sulfine invention entitled	bject matter	which is
, the specification			THOD FOR FABRICATING	THE SAM	<u>E</u>
(check one)	<u>x</u>	is attached here	eto.		
		was filed on Application Se		as	
			nd understand the contents of ed by any amendment referred		dentified
		-	ormation which is material to the of Federal Regulations, § 1.5		on of this
foreign application	(s) for pa application	tent or inventor' n for patent or in	s under Title 35, United States s certificate listed below and ventor's certificate having a fi	have also i	dentified
Prior Foreign Appli	cation(s)			Priority Cl	aimed
2002-309319 (Number)		JAPAN (Country)	24/10/2002 (Day/Month/Year Filed)	X Yes	No
(2 (41110 01)	- <u></u>			Yes	No
(Number)		(Country)	(Day/Month/Year Filed)		
(Number)		(Country)	(Day/Month/Year Filed)	Yes	No
I hereby clai	m the ber	nefit under Title 3	5, United States Code, § 120	of any Unite	ed States

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
the patent application in Trademark Office connective (Reg. No. 28,149); Kenner Paul Devinsky (Reg. N	identified above and tected therewith: Rapha neth L. Cage (Reg. No. io. 28,553); Edward E 9); Brian E. Ferguson (ower of substitution and revocation, to prosecute to transact all business in the U.S. Patent and el V. Lupo (Reg. No. 28,363); Jack Q. Lever, Jr. 26,151); Stanislaus Aksman (Reg. No. 28,562); Kubasiewicz (Reg. No. 30,020), Michael E. (Reg. No. 36,801); Robert W. Zelnick (Reg. No. 7,136).
Please address all corres	spondence and telephor	ne calls to:
N 6	ack Q. Lever, Jr. McDERMOTT, WILL & 00 Thirteenth Street, N Vashington, D.C. 2000 202) 756-8000	.w.
instructions from <u>Ma</u> Trademark Office regar attorney and the unders	eda Patent Office ding this application v gned. In the event of	S. attorneys named herein to accept and follow as to any action to be taken in the Patent and without direct communication between the U.S. a change in the persons from whom instructions will be so notified by the undersigned.
all statements made on statements were made w punishable by fine or im-	information and belie with the knowledge that prisonment, or both, un	le herein of my own knowledge are true and that f are believed to be true; and further that these willful false statements and the like so made are der Section 1001 of Title 18 of the United States y jeopardize the validity of the application or any
Full name of sole or firs	t inventor	Osamu MATSUI
Inventor's signature	Osamu Mat	Sui Date October 20, 2003

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